

# MOC3031M, MOC3032M, MOC3033M, MOC3041M, MOC3042M, MOC3043M 6-Pin DIP Zero-Cross Optoisolators Triac Driver Output (250/400 Volt Peak)

### **Features**

- Simplifies logic control of 115 VAC power
- Zero voltage crossing
- dv/dt of 2000 V/µs typical, 1000 V/µs guaranteed
- VDE recognized (File # 94766), ordering option V (e.g., MOC3043VM)

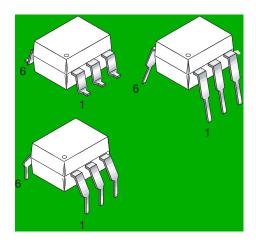
# **Applications**

- Solenoid/valve controls
- Static power switches
- Temperature controls
- AC motor starters
- Lighting controls
- AC motor drives
- E.M. contactors
- Solid state relays

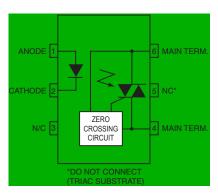
# **Description**

The MOC303XM and MOC304XM devices consist of a AlGaAs infrared emitting diode optically coupled to a monolithic silicon detector performing the function of a zero voltage crossing bilateral triac driver.

They are designed for use with a triac in the interface of logic systems to equipment powered from 115 VAC lines, such as teletypewriters, CRTs, solid-state relays, industrial controls, printers, motors, solenoids and consumer appliances, etc.



# **Schematic**



# Absolute Maximum Ratings (T<sub>A</sub> = 25°C unless otherwise noted)

Parameters	Symbol	Device	Value	Units
TOTAL DEVICE				
Storage Temperature	T <sub>STG</sub>	All	-40 to +150	°C
Operating Temperature	T <sub>OPR</sub>	All	-40 to +85	°C
Lead Solder Temperature	T <sub>SOL</sub>	All	260 for 10 sec	°C
Junction Temperature Range	TJ	All	-40 to +100	°C
Isolation Surge Voltage <sup>(1)</sup> (peak AC voltage, 60Hz, 1 sec duration)	V <sub>ISO</sub>	All	7500	Vac(pk)
Total Device Power Dissipation @ 25°C	P <sub>D</sub>	All	250	mW
Derate above 25°C			2.94	mW/°C
EMITTER				
Continuous Forward Current	IF	All	60	mA
Reverse Voltage	V <sub>R</sub>	All	6	V
Total Power Dissipation 25°C Ambient	P <sub>D</sub>	All	120	mW
Derate above 25°C			1.41	mW/°C
DETECTOR	-1			
Off-State Output Terminal Voltage	V <sub>DRM</sub>	MOC3031M/2M/3M	250	V
		MOC3041M/2M/3M	400	
Peak Repetitive Surge Current (PW = 100 μs, 120 pps)	I <sub>TSM</sub>	All	1	А
Total Power Dissipation @ 25°C Ambient	P <sub>D</sub>	All	150	mW
Derate above 25°C		All	1.76	mW/°C

# **Electrical Characteristics** (T<sub>A</sub> = 25°C Unless otherwise specified)

### **Individual Component Characteristics**

Parameters	Test Conditions	Symbol	Device	Min	Тур	Max	Units
EMITTER					•	•	•
Input Forward Voltage	I <sub>F</sub> = 30 mA	V <sub>F</sub>	All		1.25	1.5	٧
Reverse Leakage Current	V <sub>R</sub> = 6 V	I <sub>R</sub>	All		0.01	100	μA
DETECTOR							
Peak Blocking Current, Either Direction	Rated V <sub>DRM</sub> , I <sub>F</sub> = 0 (note 1)	I <sub>DRM1</sub>	All			100	nA
Peak On-State Voltage, Either Direction	$I_{TM} = 100 \text{ mA peak}, I_F = 0$	V <sub>TM</sub>	All		1.8	3	V
Critical Rate of Rise of Off-State Voltage	I <sub>F</sub> = 0 (Figure 9, note 3)	dv/dt	All	1000			V/µs

# Transfer Characteristics ( $T_A = 25$ °C Unless otherwise specified.)

DC Characteristics	Test Conditions	Symbol	Device	Min	Тур	Max	Units
LED Trigger Current	Main terminal voltage = 3V (note 2)	I <sub>FT</sub>	MOC3031M/ MOC3041M			15	mA
			MOC3032M/ MOC3042M			10	
			MOC3033M/ MOC3043M			5	
Holding Current, Either Direction		I <sub>H</sub>	All		400		μΑ

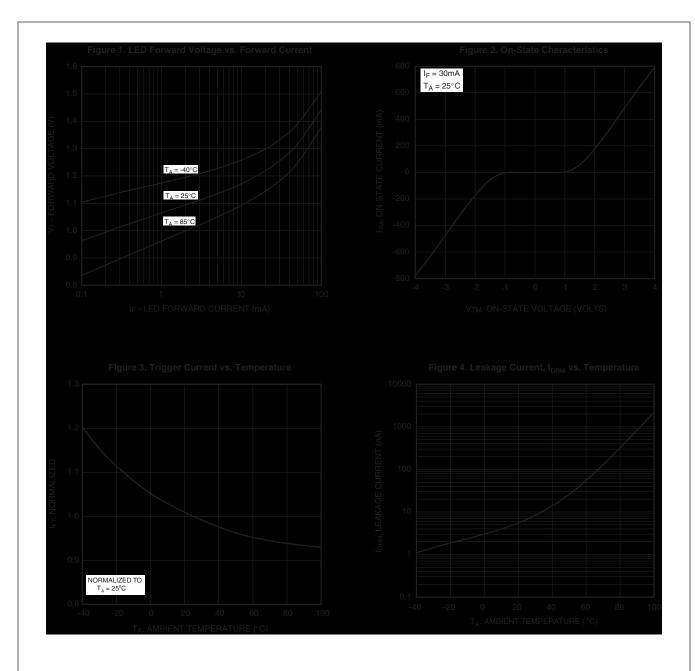
<sup>1.</sup> Isolation surge voltage,  $V_{\rm ISO}$ , is an internal device dielectric breakdown rating. For this test, Pins 1 and 2 are common, and Pins 4, 5 and 6 are

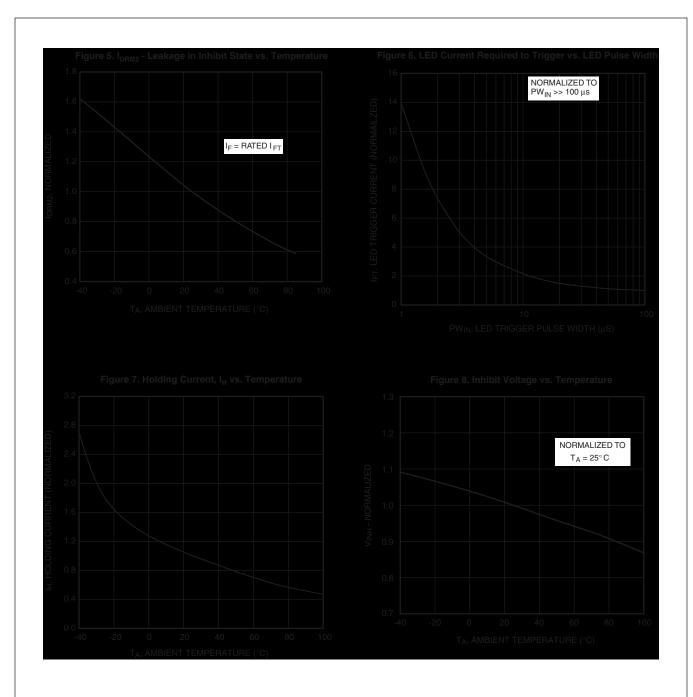
# **Zero Crossing Characteristics** ( $T_A = 25$ °C Unless otherwise specified.)

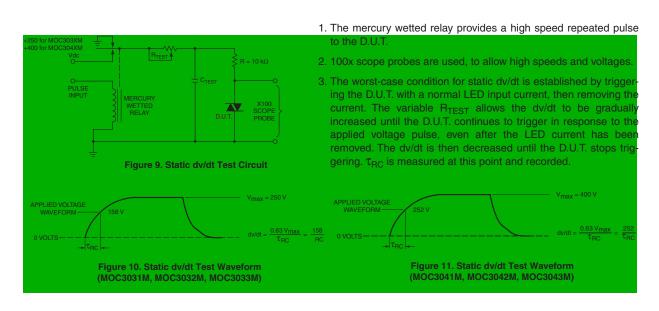
Characteristics	Test Conditions	Symbol	Device	Min	Тур	Max	Units
Inhibit Voltage	I <sub>F</sub> = rated I <sub>FT</sub> , MT1-MT2 voltage above which device will not trigger off-state	V <sub>IH</sub>	All			20	V
Leakage in Inhibited State	$I_F$ = rated $I_F$ , rated $V_{DRM}$ , off-state	I <sub>DRM2</sub>	All			500	μΑ

### Note

- 1. Test voltage must be applied within dv/dt rating.
- 2. All devices are guaranteed to trigger at an I<sub>F</sub> value less than or equal to max I<sub>FT</sub>. Therefore, recommended operating I<sub>F</sub> lies between max I<sub>FT</sub> (15 mA for MOC3031M & MOC3041M, 10 mA for MOC3032M & MOC3042M, 5 mA for MOC3033M & MOC3043M) and absolute max I<sub>F</sub> (60 mA).
- 3. This is static dv/dt. See Figure 9 for test circuit. Commutating dv/dt is a function of the load-driving thyristor(s) only.

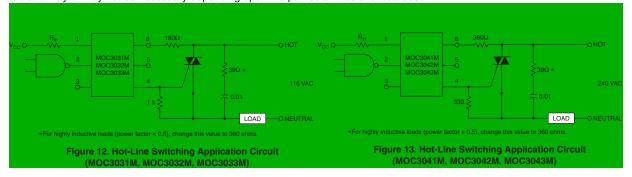


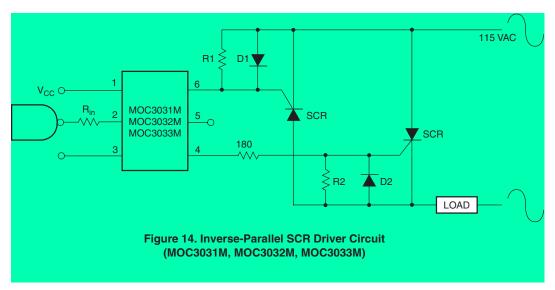




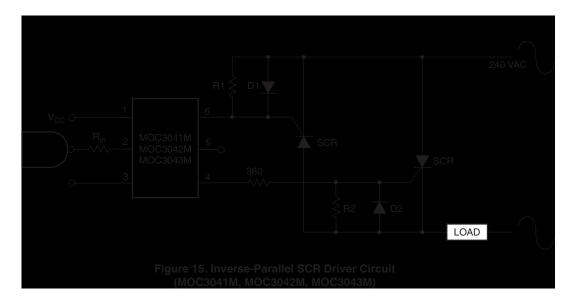
Typical circuit (Fig 12, 13) for use when hot line switching is required. In this circuit the "hot" side of the line is switched and the load connected to the cold or neutral side. The load may be connected to either the neutral or hot line.

 $R_{in}$  is calculated so that  $I_F$  is equal to the rated  $I_{FT}$  of the part, 5 mA for the MOC3033M and MOC3043M, 10 mA for the MOC3032M and MOC3042M, or 15 mA for the MOC3031M and MOC3041M. The 39 ohm resistor and 0.01  $\mu$ F capacitor are for snubbing of the triac and may or may not be necessary depending upon the particular triac and load used.



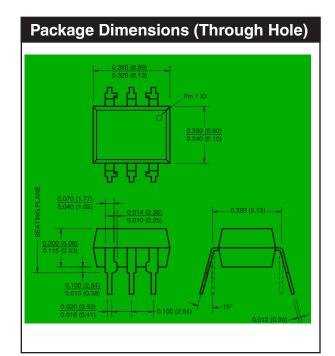


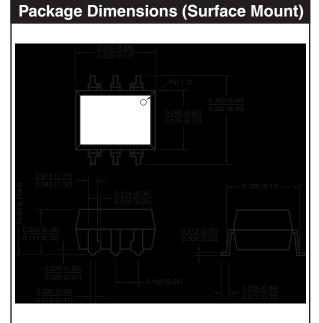
Suggested method of firing two, back-to-back SCR's with a Fairchild triac driver. Diodes can be 1N4001; resistors, R1 and R2, are optional 1 k ohm.

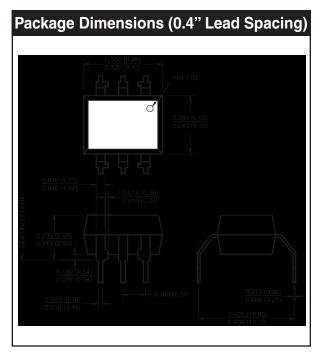


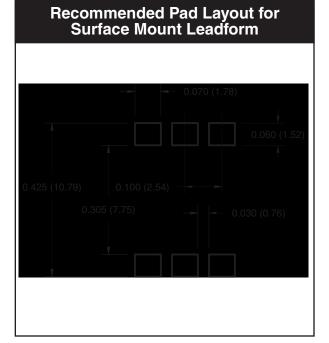
Suggested method of firing two, back-to-back SCR's with a Fairchild triac driver. Diodes can be 1N4001; resistors, R1 and R2, are optional 330 ohm.

Note: This optoisolator should not be used to drive a load directly. It is intended to be a trigger device only.





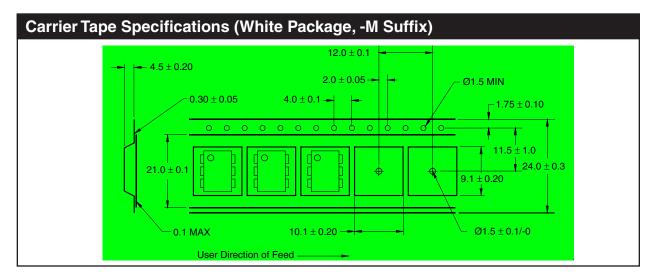




NOTE All dimensions are in inches (millimeters)

# **Ordering Information**

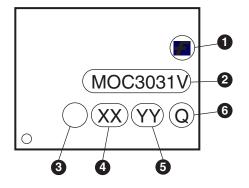
Option	Order Entry Identifier	Description
S	S	Surface Mount Lead Bend
SR2	SR2	Surface Mount; Tape and reel
Т	Т	0.4" Lead Spacing
V	V	VDE 0884
TV	TV	VDE 0884, 0.4" Lead Spacing
SV	SV	VDE 0884, Surface Mount
SR2V	SR2V	VDE 0884, Surface Mount, Tape & Reel



## **NOTE**

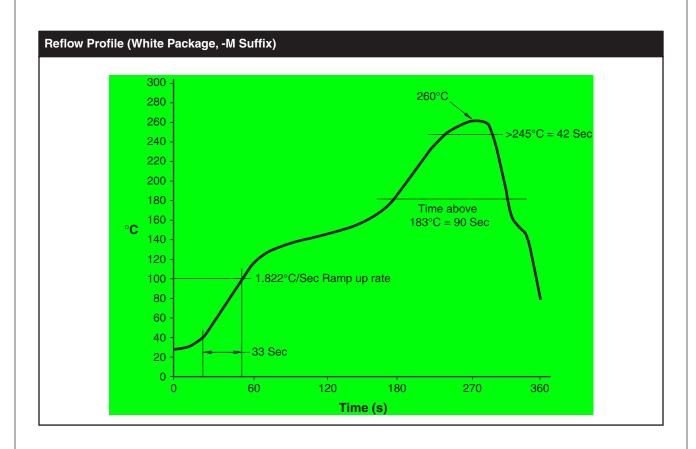
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# **Marking Information**



Definiti	Definitions					
1	Fairchild logo					
2	Device number					
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)					
4	One digit year code, e.g., '3'					
5	Two digit work week ranging from '01' to '53'					
6	Assembly package code					

\*Note - Parts that do not have the 'V' option (see definition 3 above) that are marked with date code '325' or earlier are marked in portrait format.



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Datasheet Identification	Product Status	Definition
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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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